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A

B

C

D

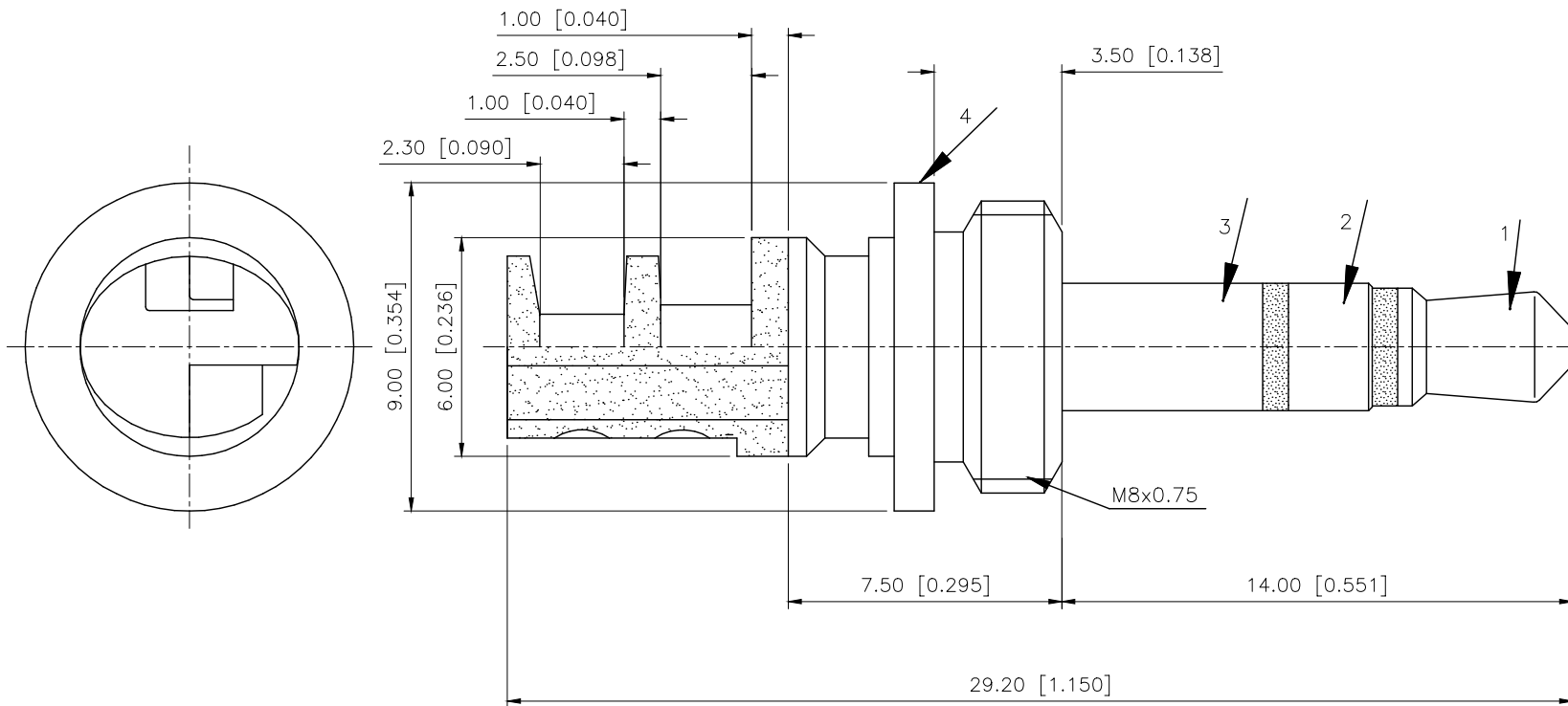
A

B

C

D

REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.06.30	阿树



技术标准:

- 外观: 各部件表面应清洁,不得有锈、毛刺、裂纹或其他机械损伤.
- 绝缘耐力: 各导体间应能受AC500V, 1分钟的作用,而无电流击穿和飞弧现象.
- 绝缘电阻: 在 DC 500 V, 100MΩ以上.
- 接触抵抗值: 各导体间的接触电阻最大为30mΩ.
- 抗弯力: 承受 3.2 ± 0.230 Kg的力而不弯曲.
- 抗断力: 承受 6.8Kg 的力而不会折断.

5	Injection molding assembly	Black	--	POM
4	Base	Gold	1	H59Lead free copper
3	座通	Gold	1	H59Lead free copper
2	Double copper beads	Gold	1	Brass
1	Contact nail	Gold	1	H59Lead free copper
ITEM	PAPT NAMF	PLATING	PCS	MATERIAL

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAuCES	



DESIGN	阿树	VIEW:	MODEL TYPE: PHONE JACK
CHECKED		UNIT: mm/in	PART NO.: PT-35051
APPROVED		SIZE: A4	DWG NO.: X-PT-35051

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SCALE	PAGE	REVISION
N/A	1/1	A1

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